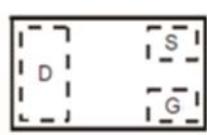
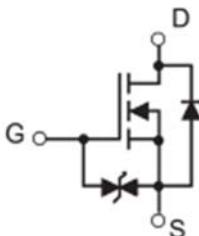


20V N-Channel MOSFETs
SDM380N02AK
Description

<p>Features</p> <ul style="list-style-type: none"> • $V_{DS}=20V$, $I_D=0.75A$ • $R_{DS(ON)} < 0.38\Omega$ @ $V_{GS} = 4.5V$ • $R_{DS(ON)} < 0.45\Omega$ @ $V_{GS} = 2.5V$ • N-Channel Switch with Low $R_{DS(on)}$ • Operated at Low Logic Level Gate Drive • Surface Mount Package • ESD Protected 	<p>Application</p> <ul style="list-style-type: none"> • Battery Protection • Load Switch • Power Management
<p>Package</p>    <p>DFN1006-3L</p>	

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		20	V
V_{GSS}	Gate-Source Voltage		± 10	V
I_D	Continuous Drain Current	$T_c = 25^\circ C$	0.75	A
		$T_c = 100^\circ C$	0.5	
I_{DM}	Pulsed Drain Current ^{note1}		3	A
P_D	Power Dissipation	$T_A = 25^\circ C$	0.15	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		833	$^\circ C/W$
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ C$

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	20	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=16\text{V}, V_{GS}=0\text{V}$,	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$	-	-	± 10	μA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.3	0.65	1	V
$R_{DS(\text{on})}$ note2	Static Drain-Source on-Resistance	$V_{GS}=4.5\text{V}, I_D=0.5\text{A}$	-	0.25	0.38	Ω
		$V_{GS}=2.5\text{V}, I_D=0.5\text{A}$	-	0.35	0.45	
g_{FS}	Forward Transconductance	$V_{DS}=10\text{V}, I_D=0.4\text{A}$	0.8	-	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=16\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$	-	79	120	pF
C_{oss}	Output Capacitance		-	13	20	pF
C_{rss}	Reverse Transfer Capacitance		-	9	15	pF
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=10\text{V}, I_D=0.5\text{A}, R_{\text{GEN}}=10\Omega, V_{GS}=4.5\text{V}$	-	6.7	-	ns
t_r	Turn-on Rise Time		-	4.8	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	17.3	-	ns
t_f	Turn-off Fall Time		-	7.4	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Maximum Continuous Drain to Source Diode Forward Current	-	-	0.75	A	
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	3	A	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_s=0.5\text{A}$	-	0.7	1.3	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

Typical Performance Characteristics

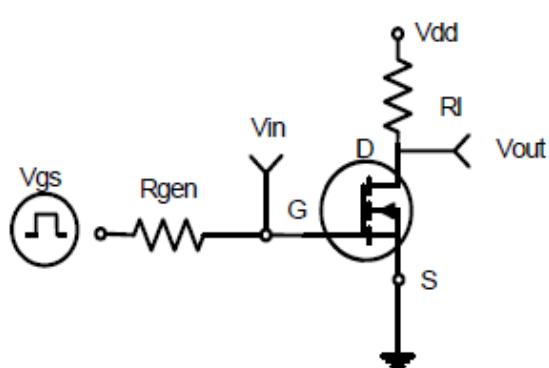


Figure1:Switching Test Circuit

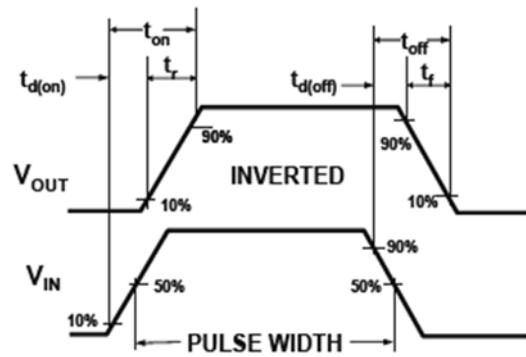
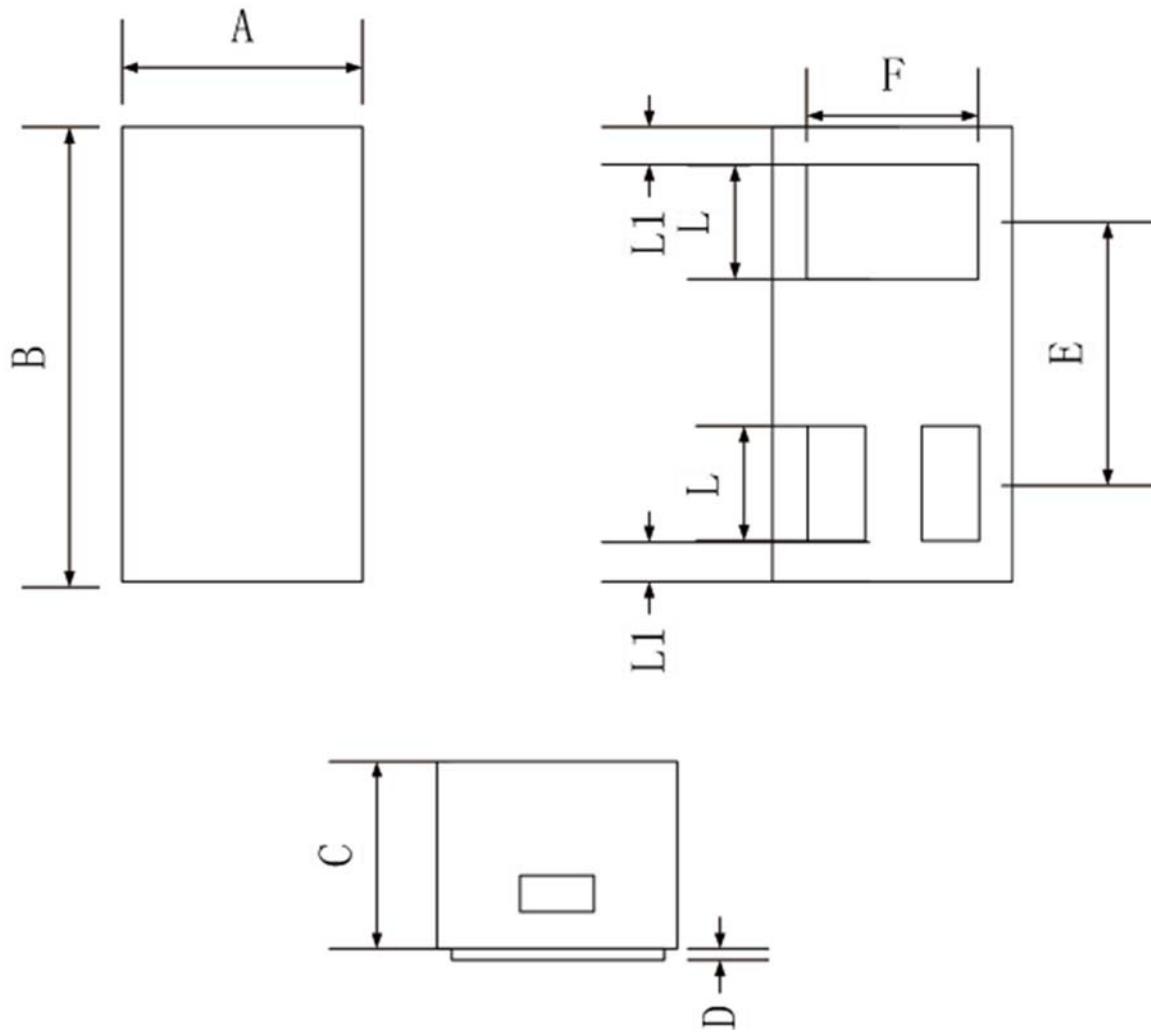


Figure2:Switching Waveforms

Package Mechanical Data



	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.55	0.60	0.65
B	0.95	1.00	1.05
C	0.44	0.47	0.50
D	0.00	0.03	0.05
E	-	0.65	-
F	0.40	0.50	0.60
L	0.20	0.25	0.30
L1	0.05REF		